INFORMATION DISCLOSURE CITATION

(USE SEVERAL SHEETS IF NECESSARY)

ATTY DOCKET NO.	SERIAL NO.
POU920040003US1	UNKNOWN
APPLICANT(S) CAPLESS	Mail Yabel # 363646191 US
CHUET AL.	363646791 US
FILING DATE 3/30/064	GROUP 3744 UNKNOWN

			U.S. PATEN	T DOCUMENT	8							
XAMINER ITIAL		DOCUMENT NUMBER	DATE		NAME			SUBC	LASS	FILING DATE IF APPROPRIATE		
75	AA	5,036,677	08/06/1991	Neuenfel	Neuenfeldt et al.			259				
M	AB	5,884,489	03/23/1999	Hughes e	Hughes et al.			3.4				
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			FOREIGN PAT	ENT DOCUME	ENTS							
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M	AF	GB 2,129,113 A	10/12/1983	GB	F25D	13/00		х	Yes			
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		ОТИЕВ ПОС	IMENTS (Including	Author Title De	nte Pertinant	Pages Fig.)						
M	AG	Chu et al., "Method and Apparatus For Combined Air and Liquid Cooling Of Stacked Electronics Components", pending U.S. patent application, Serial No. 10/303,284, filed November 25, 2002.										
M	AH	Chu et al., "Method and Sys application, Serial No. 10/6			acks Using	g Pre-Cool	led Ai	r", pen	ding 1	U.S. patent		

EXAMINER: Initial here if reference obsidered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.